

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST
CONVEYING PARTY DATA	
Name	Execution Date
DEUTSCHE BANK AG NEW YORK BRANCH, AS COLLATERAL AGENT	06/23/2022
RECEIVING PARTY DATA	
Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
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State/Country:	ARIZONA
Postal Code:	85008
PROPERTY NUMBERS Total: 7	
Property Type	Number
Application Number:	16148072
Application Number:	14685990
Application Number:	14684635
Application Number:	16059756
Application Number:	16544311
Application Number:	17302119
Application Number:	16661050
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ATTORNEY DOCKET NUMBER:	06/23/2022 LIEN RELEASE
NAME OF SUBMITTER:	KELLY A. HALL
SIGNATURE:	/Kelly A. Hall/
DATE SIGNED:	07/25/2022

PATENT

Total Attachments: 4

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**RELEASE OF
SECURITY INTEREST IN PATENTS**

This Release of Security Interest in Patents (“Patent Release”) is made as of June 23, 2022, by **DEUTSCHE BANK AG NEW YORK BRANCH**, a German banking corporation (the “Collateral Agent”) in favor of **SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC**, a Delaware limited liability company with an address at 5005 McDowell Road, Maildrop A700, Phoenix, Arizona 85008 (the “Grantor”).

W I T N E S S E T H:

WHEREAS, the “Grantor entered into the following patent security agreements with Collateral Agent (collectively, the “Patent Security Agreements”, and each, a “Patent Security Agreement”):

- Patent Security Agreement dated January 22, 2019 with Collateral Agent, notice of which was recorded on February 13, 2019 at the United States Patent and Trademark Office (the “USPTO”) at Reel 048327, Frame 0670;
- Patent Security Agreement dated April 15, 2016 with Collateral Agent, notice of which was recorded on April 15, 2016 at the USPTO at Reel 038620, Frame 0087 (a corrective assignment was recorded at Reel 039853, Frame 0001);
- Patent Security Agreement dated October 18, 2018 with Collateral Agent, notice of which was recorded on November 1, 2018 at the USPTO at Reel 047399, Frame 0631;
- Patent Security Agreement dated October 15, 2019 with Collateral Agent, notice of which was recorded on November 26, 2019 at the USPTO at Reel 051145, Frame 0062 (a corrective assignment was recorded at Reel 051170, Frame 0781);
- Patent Security Agreement dated February 13, 2020 with Collateral Agent, notice of which was recorded on October 16, 2020 at the USPTO at Reel 054090, Frame 0617; and
- Patent Security Agreement dated July 28, 2021 with Collateral Agent, notice of which was recorded on August 2, 2021 at the USPTO at Reel 057054, Frame 0706.

Capitalized terms used but not otherwise defined herein have the meanings given to them in the Patent Security Agreements.

WHEREAS, the Grantor granted the Collateral Agent, under the terms of the Patent Security Agreements, a continuing security interest (the “Security Interest”) in favor of the Collateral Agent, in and to its Patent Collateral, including the Patents listed in Schedule 1.

WHEREAS, the Collateral Agent has agreed to terminate and release its security interest in the Patents listed in Schedule 1 as herein provided.

NOW, THEREFORE, in consideration of the foregoing and intending to be legally bound, the Collateral Agent, for itself and on behalf of the lenders in association with the

Security Interest, hereby releases, terminates and discharges any and all of its interest in the Patents listed in Schedule 1 hereto, and assigns, transfers and conveys to the Grantor any interest in such intellectual property, including the Security Interest.

[Remainder of this page intentionally left blank; signature page follows]

IN WITNESS WHEREOF, the Collateral Agent has caused this Patent Release to be executed as of the day and year first written above.

**DEUTSCHE BANK AG NEW YORK
BRANCH,**
as Collateral Agent

By: _____ 

Name:
Title:

By: _____ *Suzan Onal*

Name:
Title:

SCHEDULE 1

PATENTS

Title	Patent No.	Patent Date	App. No.	App. Date
METHODS AND APPARATUS FOR A POWER SUPPLY CONTROL CIRCUIT	11039504	6/15/2021	16148072	10/1/2018
DETERMINING BATTERY STATE OF CHARGE USING AN OPEN CIRCUIT VOLTAGE MEASURED PRIOR TO A DEVICE OPERATION STAGE	10094880	10/9/2018	14685990	4/14/2015
VARIABLE-FREQUENCY SAMPLING OF BATTERY VOLTAGE TO DETERMINE FUEL GAUGE POWER MODE	10095297	10/9/2018	14684635	4/13/2015
VARIABLE-FREQUENCY SAMPLING OF BATTERY VOLTAGE TO DETERMINE FUEL GAUGE POWER MODE	10423211	9/24/2019	16059756	8/9/2018
VARIABLE-FREQUENCY SAMPLING OF BATTERY VOLTAGE TO DETERMINE FUEL GAUGE POWER MODE	10963033	3/30/2021	16544311	8/19/2019
METHODS AND APPARATUS FOR A POWER SUPPLY CONTROL CIRCUIT	N/A	N/A	17302119	4/23/2021
METHODS AND SYSTEM FOR INDUCTION HEATING	N/A	N/A	16661050	10/23/2019